IN THE CLAIMS

Please amend the claims as follows:

Claim 1 (Currently Amended): An apparatus, for heat-processing a mask substrate, comprising:

a heating plate for heating the mask substrate, the mask substrate <u>disposed on a first</u> side of the heating plate and including a front surface and a side surface;

heating means for heating the heating plate; and

a frame member <u>disposed on the first side</u> of the heating plate so as to overlap the heating means as viewed from the first side, having an inner peripheral surface and a first clearance between the inner peripheral surface and the side surface, being detachably disposed to the heating plate so that the frame member is disposed around the mask substrate.

Claim 2 (Cancelled).

Claim 3 (Previously Presented): The heat processing apparatus as set forth in claim 1, wherein the inner peripheral surface is curved in a concave shape.

Claim 4 (Previously Presented): The heat processing apparatus as set forth in claim 1, wherein the inner peripheral surface is curved in a convex shape.

Claim 5 (Previously Presented): The heat processing apparatus as set forth in claim 3, wherein the inner peripheral surface is a mirror surface.

Claim 6 (Previously Presented): The heat processing apparatus as set forth in claim 3, wherein the inner peripheral surface is a rough surface.

Claim 7 (Currently Amended): The heat processing apparatus as set forth in claim 3,

An apparatus, for heat-processing a mask substrate, comprising:

a heating plate for heating the mask substrate, the mask substrate including a front surface and a side surface;

heating means for heating the heating plate; and

a frame member, having an inner peripheral surface and a first clearance between the inner peripheral surface and the side surface, being detachably disposed to the heating plate so that the frame member is disposed around the mask substrate further comprising:

a driving mechanism for moving configured to move the frame member so that a distance between the frame member and the side surface of the mask substrate placed on the heating plate varies in a direction perpendicular to the side surface.

Claim 8 (Original): The heat processing apparatus as set forth in claim 7, further comprising:

means for detecting a temperature of the mask substrate; and a controlling portion for controlling the driving mechanism in accordance with the detected temperature.

Claim 9 (Previously Presented): The heat processing apparatus as set forth in claim 8, wherein the controlling portion determines whether the temperature of the mask substrate is in an increasing state or in a constant state in accordance with the detected temperature, controls the driving mechanism so that the distance between the frame member and the side surface of the mask substrate placed on the heating plate becomes a first distance when the temperature of the mask substrate is in the increasing state and a second distance

smaller than the first distance when the temperature of the mask substrate is in the constant state.

Claim 10 (Previously Presented): The heat processing apparatus as set forth in claim 1, wherein the frame member is divided along the inner peripheral surface in a peripheral direction of the mask substrate placed on the heating plate.

Claim 11 (Cancelled).

Claim 12 (Original): The heat processing apparatus as set forth in claim 1, wherein the mask substrate is an approximately square glass substrate having a side surface of six inches long, and

wherein the heating plate is a circular plate for heating a semiconductor wafer having a diameter of 10 inches.

Claims 13-14 (Canceled).

Claim 15 (Previously Presented): The heat processing apparatus as set forth in claim 1, further comprising a supporting portion for movably supporting the frame member so that a second clearance is formed between the frame member and the heating plate.

Claim 16 (Previously Presented): The heat processing apparatus as set forth in claim 15, wherein the frame member and the supporting portion comprise material having a heat conductivity.

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Claim 17 (New): The heat processing apparatus as set forth in claim 1, further comprising a heater, different than the heating means, disposed in the frame member.

Claim 18 (New): The heat processing apparatus as set forth in claim 1, further comprising a clearance between the frame member and the first side of the heating plate.